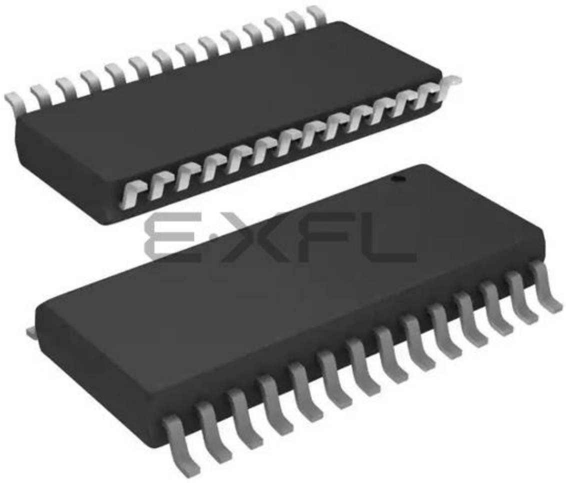

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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	16-Bit
Speed	32MHz
Connectivity	I²C, IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LVD, POR, PWM, WDT
Number of I/O	24
Program Memory Size	16KB (5.5K x 24)
Program Memory Type	FLASH
EEPROM Size	512 x 8
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 19x10b/12b; D/A 2x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	28-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic24f16km202-i-so

TABLE 4-10: MCCP3 REGISTER MAP

File Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
CCP3CON1L(1)	188h	CCPON	—	CCPSIDL	r	TMRSYNC	CLKSEL2	CLKSEL1	CLKSEL0	TMRPS1	TMRPS0	T32	CCSEL	MOD3	MOD2	MOD1	MOD0	0000
CCP3CON1H(1)	18Ah	OPSSRC	RTRGEN	—	—	IOPS3	IOPS2	IOPS1	IOPS0	TRIGEN	ONESHOT	ALTSYNC	SYNC4	SYNC3	SYNC2	SYNC1	SYNC0	0000
CCP3CON2L(1)	18Ch	PWMRSEN	ASDGM	—	SSDG	—	—	—	—	ASDG7	ASDG6	ASDG5	ASDG4	ASDG3	ASDG2	ASDG1	ASDG0	0000
CCP3CON2H(1)	18Eh	OENSYNC	—	OCFEN	OCEEN	OCDEN	OCCEN	OCBEN	OCAEN	ICGSM1	ICGSM0	—	AUXOUT1	AUXOUT0	ICS2	ICS1	ICS0	0100
CCP3CON3L(1)	190h	—	—	—	—	—	—	—	—	—	—	DT5	DT4	DT3	DT2	DT1	DT0	0000
CCP3CON3H(1)	192h	OETRIG	OSCNT2	OSCNT1	OSCNT0	—	OUTM2	OUTM1	OUTM0	—	—	POLACE	POLBDF	PSSACE1	PSSACE0	PSSBDF1	PSSBDF0	0000
CCP3STAT(1)	194h	—	—	—	—	—	—	—	—	CCPTRIG	TRSET	TRCLR	ASEVT	SCEVT	ICDIS	ICOV	ICBNE	0000
CCP3TMRL(1)	198h	MCCP3 Time Base Register Low Word																0000
CCP3TMRH(1)	19Ah	MCCP3 Time Base Register High Word																0000
CCP3PRL(1)	19Ch	MCCP3 Time Base Period Register Low Word																FFFF
CCP3PRH(1)	19Eh	MCCP3 Time Base Period Register High Word																FFFF
CCP3RAL(1)	1A0h	Output Compare 3 Data Word A																0000
CCP3RBL(1)	1A4h	Output Compare 3 Data Word B																0000
CCP3BUFL(1)	1A8h	Input Capture 3 Data Buffer Low Word																0000
CCP3BUFH(1)	1AAh	Input Capture 3 Data Buffer High Word																0000

Legend: x = unknown, u = unchanged, — = unimplemented, q = value depends on condition, r = reserved.

Note 1: These registers are available only on PIC24F(V)16KM2XX devices.

TABLE 4-15: UART1 REGISTER MAP

File Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
U1MODE	220h	UARTEN	—	USIDL	IREN	RTSMD	—	UEN1	UEN0	WAKE	LPBACK	ABAUD	URXINV	BRGH	PDSEL1	PDSEL0	STSEL	0000
U1STA	222h	UTXISEL1	UTXINV	UTXISEL0	—	UTXBRK	UTXEN	UTXBF	TRMT	URXISEL1	URXISEL0	ADDEN	RIDLE	PERR	FERR	OERR	URXDA	0110
U1TXREG	224h	—	—	—	—	—	—	—	UART1 Transmit Register									xxxx
U1RXREG	226h	—	—	—	—	—	—	—	UART1 Receive Register									0000
U1BRG	228h	Baud Rate Generator Prescaler																0000

Legend: x = unknown, u = unchanged, — = unimplemented, q = value depends on condition, r = reserved.

TABLE 4-16: UART2 REGISTER MAP

File Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
U2MODE(1)	230h	UARTEN	—	USIDL	IREN	RTSMD	—	UEN1	UEN0	WAKE	LPBACK	ABAUD	URXINV	BRGH	PDSEL1	PDSEL0	STSEL	0000
U2STA(1)	232h	UTXISEL1	UTXINV	UTXISEL0	—	UTXBRK	UTXEN	UTXBF	TRMT	URXISEL1	URXISEL0	ADDEN	RIDLE	PERR	FERR	OERR	URXDA	0110
U2TXREG(1)	234h	—	—	—	—	—	—	—	UART2 Transmit Register									xxxx
U2RXREG(1)	236h	—	—	—	—	—	—	—	UART2 Receive Register									0000
U2BRG(1)	238h	Baud Rate Generator Prescaler																0000

Legend: x = unknown, u = unchanged, — = unimplemented, q = value depends on condition, r = reserved.
Note 1: These registers are available only on PIC24F(V)16KM2XX devices.

5.0 FLASH PROGRAM MEMORY

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information on Flash programming, refer to the *"PIC24F Family Reference Manual"*, **"Program Memory"** (DS39715).

The PIC24FV16KM204 family of devices contains internal Flash program memory for storing and executing application code. The memory is readable, writable and erasable when operating with VDD over 1.8V.

Flash memory can be programmed in three ways:

- In-Circuit Serial Programming™ (ICSP™)
- Run-Time Self-Programming (RTSP)
- Enhanced In-Circuit Serial Programming (Enhanced ICSP)

ICSP allows a PIC24FXXXXX device to be serially programmed while in the end application circuit. This is simply done with two lines for the programming clock and programming data (which are named PGECx and PGEDx, respectively), and three other lines for power (VDD), ground (VSS) and Master Clear/Program Mode Entry Voltage (MCLR/VPP). This allows customers to manufacture boards with unprogrammed devices and then program the microcontroller just before shipping the product. This also allows the most recent firmware or custom firmware to be programmed.

Run-Time Self-Programming (RTSP) is accomplished using TBLRD (Table Read) and TBLWT (Table Write) instructions. With RTSP, the user may write program memory data in blocks of 32 instructions (96 bytes) at a time, and erase program memory in blocks of 32, 64 and 128 instructions (96,192 and 384 bytes) at a time.

The NVMOP<1:0> (NVMCON<1:0>) bits decide the erase block size.

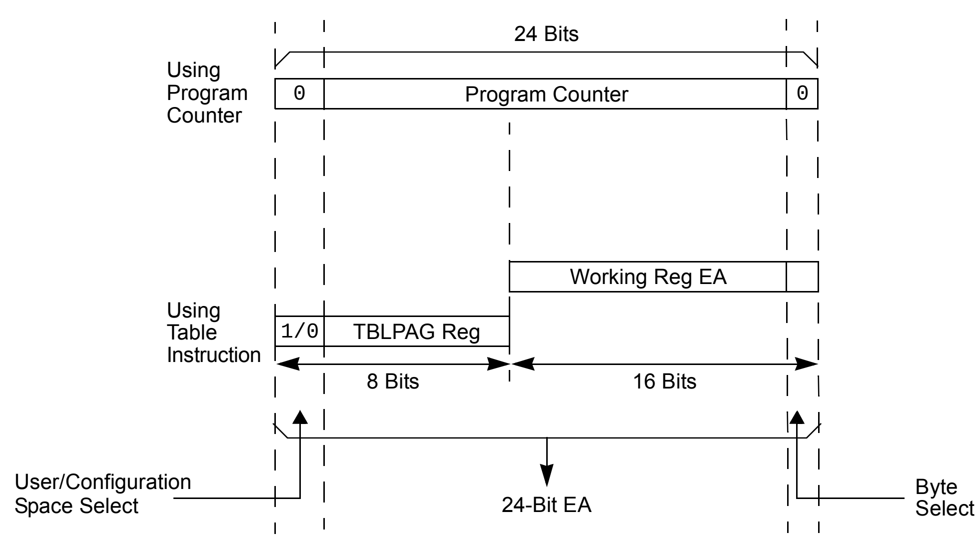
5.1 Table Instructions and Flash Programming

Regardless of the method used, Flash memory programming is done with the Table Read and Write instructions. These allow direct read and write access to the program memory space from the data memory while the device is in normal operating mode. The 24-bit target address in the program memory is formed using the TBLPAG<7:0> bits and the Effective Address (EA) from a W register, specified in the table instruction, as depicted in Figure 5-1.

The TBLRDL and the TBLWTL instructions are used to read or write to bits<15:0> of program memory. TBLRDL and TBLWTL can access program memory in both Word and Byte modes.

The TBLRDH and TBLWTH instructions are used to read or write to bits<23:16> of program memory. TBLRDH and TBLWTH can also access program memory in Word or Byte mode.

FIGURE 5-1: ADDRESSING FOR TABLE REGISTERS



7.4.2 SOFTWARE ENABLED BOR

When BOREN<1:0> = 01, the BOR can be enabled or disabled by the user in software. This is done with the control bit, SBOREN (RCON<13>). Setting SBOREN enables the BOR to function as previously described. Clearing the SBOREN disables the BOR entirely. The SBOREN bit operates only in this mode; otherwise, it is read as '0'.

Placing BOR under software control gives the user the additional flexibility of tailoring the application to its environment without having to reprogram the device to change the BOR configuration. It also allows the user to tailor the incremental current that the BOR consumes. While the BOR current is typically very small, it may have some impact in low-power applications.

Note:	Even when the BOR is under software control, the Brown-out Reset voltage level is still set by the BORV<1:0> Configuration bits; it can not be changed in software.

7.4.3 DETECTING BOR

When BOR is enabled, the BOR bit (RCON<1>) is always reset to '1' on any BOR or POR event. This makes it difficult to determine if a BOR event has occurred just by reading the state of BOR alone. A more reliable method is to simultaneously check the state of both POR and BOR. This assumes that the POR and BOR bits are reset to '0' in the software immediately after any POR event. If the BOR bit is '1' while POR is '0', it can be reliably assumed that a BOR event has occurred.

7.4.4 DISABLING BOR IN SLEEP MODE

When BOREN<1:0> = 10, BOR remains under hardware control and operates as previously described. However, whenever the device enters Sleep mode, BOR is automatically disabled. When the device returns to any other operating mode, BOR is automatically re-enabled.

This mode allows for applications to recover from brown-out situations, while actively executing code, when the device requires BOR protection the most. At the same time, it saves additional power in Sleep mode by eliminating the small incremental BOR current.

Note:	BOR levels differ depending on device type; PIC24FV16KM204 devices are at different levels than those of PIC24F16KM204 devices. See **Section 27.0 "Electrical Characteristics"** for BOR voltage levels.

REGISTER 8-23: IPC4: INTERRUPT PRIORITY CONTROL REGISTER 4

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
—	CNIP2	CNIP1	CNIP0	—	CMIP2	CMIP1	CMIP0
bit 15							bit 8

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
—	BCL1IP2	BCL1IP1	BCL1IP0	—	SSP1IP2	SSP1IP1	SSP1IP0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15 **Unimplemented:** Read as ‘0’

bit 14-12 **CNIP<2:0>:** Input Change Notification Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 11 **Unimplemented:** Read as ‘0’

bit 10-8 **CMIP<2:0>:** Comparator Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 7 **Unimplemented:** Read as ‘0’

bit 6-4 **BCL1IP<2:0>:** MSSP1 I^2C™ Bus Collision Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 3 **Unimplemented:** Read as ‘0’

bit 2-0 **SSP1IP<2:0>:** MSSP1 SPI/I^2C Event Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

REGISTER 8-33: IPC20: INTERRUPT PRIORITY CONTROL REGISTER 20

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	R/W-1	R/W-0	R/W-0
—	—	—	—	—	ULPWUIP2	ULPWUIP1	ULPWUIP0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-3 **Unimplemented:** Read as ‘0’

bit 2-0 **ULPWUIP<2:0>:** Ultra Low-Power Wake-up Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

REGISTER 8-34: IPC24: INTERRUPT PRIORITY CONTROL REGISTER 24

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
—	CLC2IP2	CLC2IP1	CLC2IP0	—	CLC1IP2	CLC1IP1	CLC1IP0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-7 **Unimplemented:** Read as ‘0’

bit 6-4 **CLC2IP<2:0>:** CLC2 Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 3 **Unimplemented:** Read as ‘0’

bit 2-0 **CLC1IP<2:0>:** CLC1 Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

9.1 CPU Clocking Scheme

The system clock source can be provided by one of four sources:

- Primary Oscillator (POSC) on the OSCI and OSCO pins
- Secondary Oscillator (SOSC) on the SOSCI and SOSCO pins

  The PIC24FXXXXX family devices consist of two types of secondary oscillator:

  - High-Power Secondary Oscillator
  - Low-Power Secondary Oscillator

  These can be selected by using the SOSCSEL (FOSC<5>) bit.
- Fast Internal RC (FRC) Oscillator:
  - 8 MHz FRC Oscillator
  - 500 kHz Lower Power FRC Oscillator
- Low-Power Internal RC (LPRC) Oscillator with two modes:
  - High-Power/High-Accuracy mode
  - Low-Power/Low-Accuracy mode

The Primary Oscillator and 8 MHz FRC sources have the option of using the internal 4x PLL. The frequency of the FRC clock source can optionally be reduced by the programmable clock divider. The selected clock source generates the processor and peripheral clock sources.

The processor clock source is divided by two to produce the internal instruction cycle clock, FCY. In this document, the instruction cycle clock is also denoted by FOSC/2. The internal instruction cycle clock, FOSC/2, can be provided on the OSCO I/O pin for some operating modes of the Primary Oscillator.

9.2 Initial Configuration on POR

The oscillator source (and operating mode) that is used at a device Power-on Reset (POR) event is selected using Configuration bit settings. The Oscillator Configuration bit settings are located in the Configuration registers in the program memory (for more information, see **Section 25.1 "Configuration Bits"**). The Primary Oscillator Configuration bits, POSCMD<1:0> (FOSC<1:0>), and the Initial Oscillator Select Configuration bits, FNOSC<2:0> (FOSCSEL<2:0>), select the oscillator source that is used at a POR. The FRC Primary Oscillator with Postscaler (FRCDIV) is the default (unprogrammed) selection. The Secondary Oscillator, or one of the internal oscillators, may be chosen by programming these bit locations. The EC mode Frequency Range Configuration bits, POSCFREQ<1:0> (FOSC<4:3>), optimize power consumption when running in EC mode. The default configuration is "frequency range is greater than 8 MHz".

The Configuration bits allow users to choose between the various clock modes, shown in Table 9-1.

9.2.1 CLOCK SWITCHING MODE CONFIGURATION BITS

The FCKSM<1:0> Configuration bits (FOSC<7:6>) are used jointly to configure device clock switching and the FSCM. Clock switching is enabled only when FCKSM1 is programmed ('0'). The FSCM is enabled only when FCKSM<1:0> are both programmed ('00').

TABLE 9-1: CONFIGURATION BIT VALUES FOR CLOCK SELECTION

Oscillator Mode	Oscillator Source	POSCMD<1:0>	FNOSC<2:0>	Notes
8 MHz FRC Oscillator with Postscaler (FRCDIV)	Internal	11	111	**1, 2**
500 kHz FRC Oscillator with Postscaler (LPFRCDIV)	Internal	11	110	**1**
Low-Power RC Oscillator (LPRC)	Internal	11	101	**1**
Secondary (Timer1) Oscillator (SOSC)	Secondary	00	100	**1**
Primary Oscillator (HS) with PLL Module (HSPLL)	Primary	10	011	
Primary Oscillator (EC) with PLL Module (ECPLL)	Primary	00	011	
Primary Oscillator (HS)	Primary	10	010	
Primary Oscillator (XT)	Primary	01	010	
Primary Oscillator (EC)	Primary	00	010	
8 MHz FRC Oscillator with PLL Module (FRCPLL)	Internal	11	001	**1**
8 MHz FRC Oscillator (FRC)	Internal	11	000	**1**

Note 1: The OSCO pin function is determined by the OSCIOFNC Configuration bit.

2: This is the default oscillator mode for an unprogrammed (erased) device.

15.1 UARTx Baud Rate Generator (BRG)

The UARTx module includes a dedicated 16-bit Baud Rate Generator (BRG). The UxBRG register controls the period of a free-running, 16-bit timer. Equation 15-1 provides the formula for computation of the baud rate with BRGH = 0.

EQUATION 15-1: UARTx BAUD RATE WITH BRGH = 0[(1)]

$$\text{Baud Rate} = \frac{F_{CY}}{16 \cdot (\text{UxBRG} + 1)}$$

$$\text{UxBRG} = \frac{F_{CY}}{16 \cdot \text{Baud Rate}} - 1$$

Note 1: Based on $F_{CY} = F_{OSC}/2$; Doze mode and PLL are disabled.

Example 15-1 provides the calculation of the baud rate error for the following conditions:

- F_{CY} = 4 MHz
- Desired Baud Rate = 9600

The maximum baud rate (BRGH = 0) possible is $F_{CY}/16$ (for UxBRG = 0) and the minimum baud rate possible is $F_{CY}/(16 * 65536)$.

Equation 15-2 shows the formula for computation of the baud rate with BRGH = 1.

EQUATION 15-2: UARTx BAUD RATE WITH BRGH = 1[(1)]

$$\text{Baud Rate} = \frac{F_{CY}}{4 \cdot (\text{UxBRG} + 1)}$$

$$\text{UxBRG} = \frac{F_{CY}}{4 \cdot \text{Baud Rate}} - 1$$

Note 1: Based on $F_{CY} = F_{OSC}/2$; Doze mode and PLL are disabled.

The maximum baud rate (BRGH = 1) possible is $F_{CY}/4$ (for UxBRG = 0) and the minimum baud rate possible is $F_{CY}/(4 * 65536)$.

Writing a new value to the UxBRG register causes the BRG timer to be reset (cleared). This ensures the BRG does not wait for a timer overflow before generating the new baud rate.

EXAMPLE 15-1: BAUD RATE ERROR CALCULATION (BRGH = 0)[(1)]

Desired Baud Rate = F_{CY}/(16 (UxBRG + 1))

Solving for UxBRG value:

UxBRG = ((F_{CY}/Desired Baud Rate)/16) – 1
UxBRG = ((4000000/9600)/16) – 1
UxBRG = 25

Calculated Baud Rate = 4000000/(16 (25 + 1))
= 9615

Error = (Calculated Baud Rate – Desired Baud Rate)
Desired Baud Rate
= (9615 – 9600)/9600
= 0.16%

Note 1: Based on $F_{CY} = F_{OSC}/2$; Doze mode and PLL are disabled.

REGISTER 15-3: UxTXREG: UARTx TRANSMIT REGISTER

U-x	U-x	U-x	U-x	U-x	U-x	U-x	W-x
—	—	—	—	—	—	—	UTX8
bit 15							bit 8

W-x	W-x	W-x	W-x	W-x	W-x	W-x	W-x
UTX7	UTX6	UTX5	UTX4	UTX3	UTX2	UTX1	UTX0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-9 **Unimplemented:** Read as ‘0’

bit 8 **UTX8:** Data of the Transmitted Character bit (in 9-bit mode)

bit 7-0 **UTX<7:0>:** Data of the Transmitted Character bits

REGISTER 15-4: UxRXREG: UARTx RECEIVE REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R-0, HSC
—	—	—	—	—	—	—	URX8
bit 15							bit 8

R-0, HSC	R-0, HSC	R-0, HSC	R-0, HSC	R-0, HSC	R-0, HSC	R-0, HSC	R-0, HSC
URX7	URX6	URX5	URX4	URX3	URX2	URX1	URX0
bit 7							bit 0

Legend:	HSC = Hardware Settable/Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-9 **Unimplemented:** Read as ‘0’

bit 8 **URX8:** Data of the Received Character bit (in 9-bit mode)

bit 7-0 **URX<7:0>:** Data of the Received Character bits

REGISTER 16-2: RTCPWC: RTCC CONFIGURATION REGISTER 2[1]

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PWCEN	PWCPOL	PWCCPRE	PWCSPRE	RTCCLK1[2]	RTCCLK0[2]	RTCOUT1	RTCOUT0
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15 **PWCEN:** Power Control Enable bit
1 = Power control is enabled
0 = Power control is disabled

bit 14 **PWCPOL:** Power Control Polarity bit
1 = Power control output is active-high
0 = Power control output is active-low

bit 13 **PWCCPRE:** Power Control/Stability Prescaler bits
1 = PWC stability window clock is divide-by-2 of source RTCC clock
0 = PWC stability window clock is divide-by-1 of source RTCC clock

bit 12 **PWCSPRE:** Power Control Sample Prescaler bits
1 = PWC sample window clock is divide-by-2 of source RTCC clock
0 = PWC sample window clock is divide-by-1 of source RTCC clock

bit 11-10 **RTCCLK<1:0>:** RTCC Clock Select bits[2]
Determines the source of the internal RTCC clock, which is used for all RTCC timer operations.
00 = External Secondary Oscillator (SOSC)
01 = Internal LPRC Oscillator
10 = External power line source – 50 Hz
11 = External power line source – 60 Hz

bit 9-8 **RTCOUT<1:0>:** RTCC Output Select bits
Determines the source of the RTCC pin output.
00 = RTCC alarm pulse
01 = RTCC seconds clock
10 = RTCC clock
11 = Power control

bit 7-0 **Unimplemented:** Read as ‘0’

Note 1: The RTCPWC register is only affected by a POR.
2: When a new value is written to these register bits, the Seconds Value register should also be written to properly reset the clock prescalers in the RTCC.

FIGURE 16-2: ALARM MASK SETTINGS

Alarm Mask Setting (AMASK<3:0>)	Day of the Week	Month	Day	Hours	Minutes	Seconds
`0000` - Every half second `0001` - Every second		/		:	:	
`0010` - Every 10 seconds		/		:	:	s
`0011` - Every minute		/		:	:	s s
`0100` - Every 10 minutes		/		:	m :	s s
`0101` - Every hour		/		:	m m :	s s
`0110` - Every day		/		h h :	m m :	s s
`0111` - Every week	d	/		h h :	m m :	s s
`1000` - Every month		/	d d	h h :	m m :	s s
`1001` - Every year[(1)]		m m /	d d	h h :	m m :	s s

Note 1: Annually, except when configured for February 29.

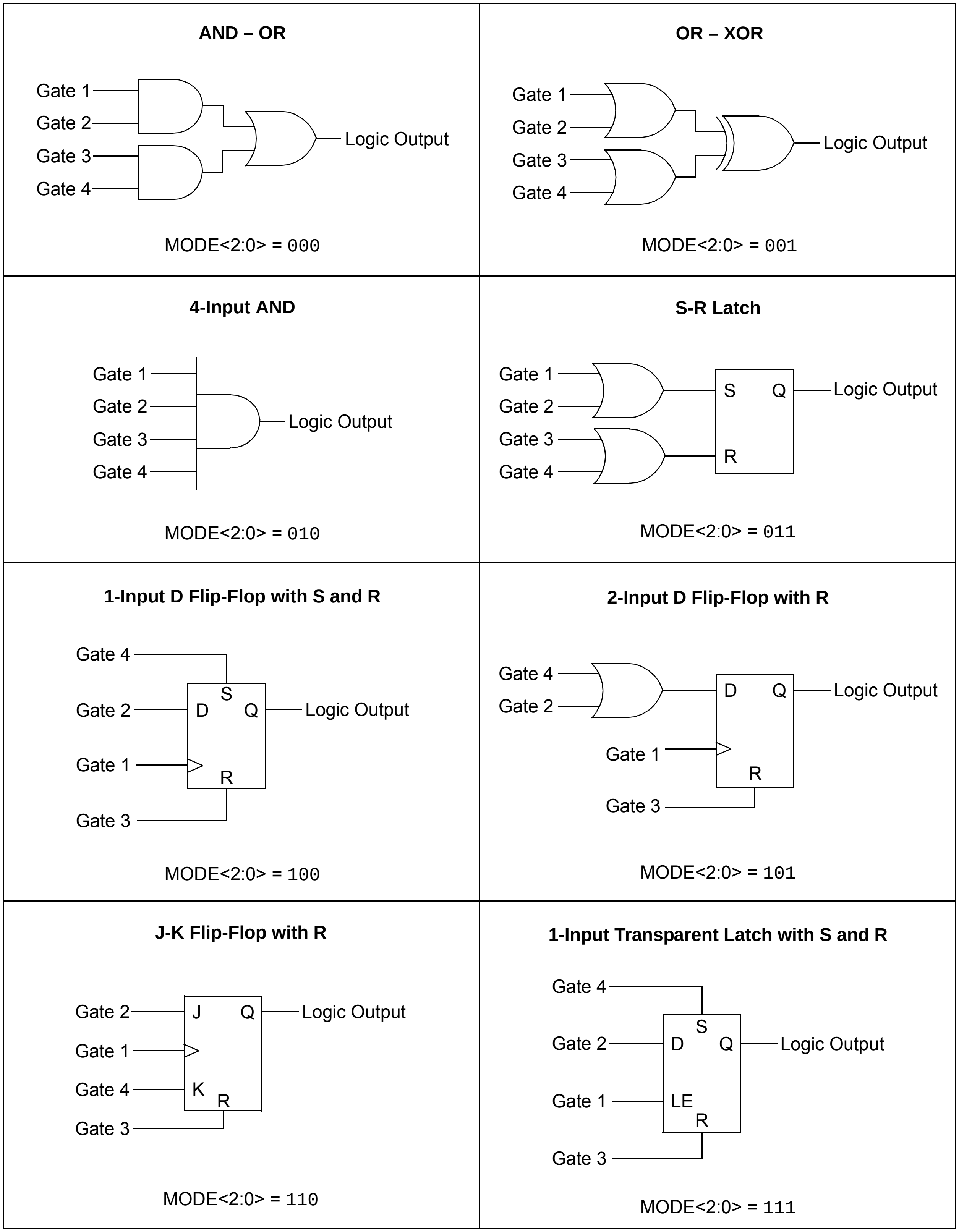
16.5 Power Control

The RTCC includes a power control feature that allows the device to periodically wake-up an external device, wait for the device to be stable before sampling wake-up events from that device and then shut down the external device. This can be done completely autonomously by the RTCC, without the need to wake from the current low-power mode (Sleep, Deep Sleep, etc.).

To enable this feature, the RTCC must be enabled (RTCEN = `1`), the PWCEN register bit must be set and the RTCC pin must be driving the PWC control signal (RTCOE = `1` and RTCCLK<1:0> = `11`).

The polarity of the PWC control signal may be chosen using the PWCPOL register bit. Active-low or active-high may be used with the appropriate external switch to turn on or off the power to one or more external devices. The active-low setting may also be used in conjunction with an open-drain setting on the RTCC pin. This setting is able to drive the GND pin(s) of the external device directly (with the appropriate external V_{DD} pull-up device), without the need for external switches. Finally, the CHIME bit should be set to enable the PWC periodicity.

FIGURE 17-2: CLCx LOGIC FUNCTION COMBINATORIAL OPTIONS



REGISTER 17-4: CLCxGLSL: CLCx GATE LOGIC INPUT SELECT LOW REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
G2D4T	G2D4N	G2D3T	G2D3N	G2D2T	G2D2N	G2D1T	G2D1N
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
G1D4T	G1D4N	G1D3T	G1D3N	G1D2T	G1D2N	G1D1T	G1D1N
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15 **G2D4T:** Gate 2 Data Source 4 True Enable bit
1 = The Data Source 4 inverted signal is enabled for Gate 2
0 = The Data Source 4 inverted signal is disabled for Gate 2

bit 14 **G2D4N:** Gate 2 Data Source 4 Negated Enable bit
1 = The Data Source 4 inverted signal is enabled for Gate 2
0 = The Data Source 4 inverted signal is disabled for Gate 2

bit 13 **G2D3T:** Gate 2 Data Source 3 True Enable bit
1 = The Data Source 3 inverted signal is enabled for Gate 2
0 = The Data Source 3 inverted signal is disabled for Gate 2

bit 12 **G2D3N:** Gate 2 Data Source 3 Negated Enable bit
1 = The Data Source 3 inverted signal is enabled for Gate 2
0 = The Data Source 3 inverted signal is disabled for Gate 2

bit 11 **G2D2T:** Gate 2 Data Source 2 True Enable bit
1 = The Data Source 2 inverted signal is enabled for Gate 2
0 = The Data Source 2 inverted signal is disabled for Gate 2

bit 10 **G2D2N:** Gate 2 Data Source 2 Negated Enable bit
1 = The Data Source 2 inverted signal is enabled for Gate 2
0 = The Data Source 2 inverted signal is disabled for Gate 2

bit 9 **G2D1T:** Gate 2 Data Source 1 True Enable bit
1 = The Data Source 1 inverted signal is enabled for Gate 2
0 = The Data Source 1 inverted signal is disabled for Gate 2

bit 8 **G2D1N:** Gate 2 Data Source 1 Negated Enable bit
1 = The Data Source 2 inverted signal is enabled for Gate 1
0 = The Data Source 2 inverted signal is disabled for Gate 1

bit 7 **G1D4T:** Gate 1 Data Source 4 True Enable bit
1 = The Data Source 4 inverted signal is enabled for Gate 1
0 = The Data Source 4 inverted signal is disabled for Gate 1

bit 6 **G1D4N:** Gate 1 Data Source 4 Negated Enable bit
1 = The Data Source 4 inverted signal is enabled for Gate 1
0 = The Data Source 4 inverted signal is disabled for Gate 1

bit 5 **G1D3T:** Gate 1 Data Source 3 True Enable bit
1 = The Data Source 3 inverted signal is enabled for Gate 1
0 = The Data Source 3 inverted signal is disabled for Gate 1

bit 4 **G1D3N:** Gate 1 Data Source 3 Negated Enable bit
1 = The Data Source 3 inverted signal is enabled for Gate 1
0 = The Data Source 3 inverted signal is disabled for Gate 1

24.3 Pulse Generation and Delay

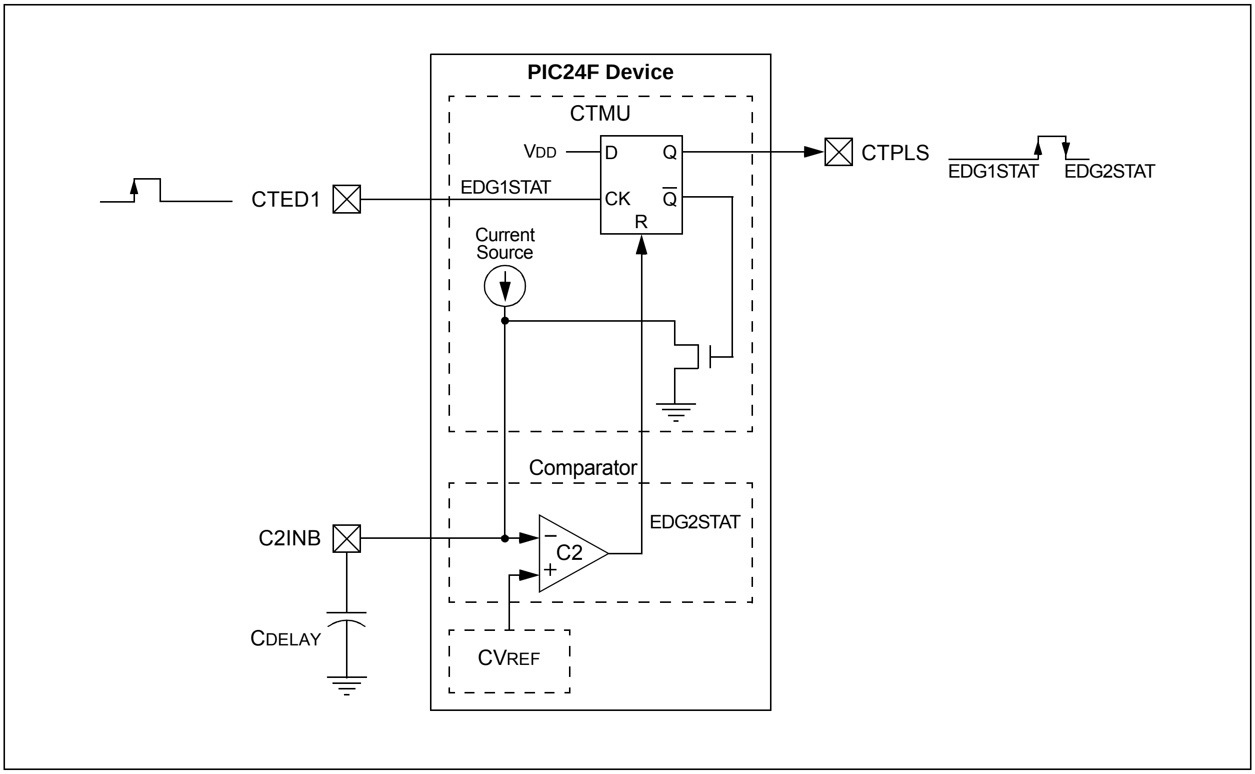
The CTMU module can also generate an output pulse with edges that are not synchronous with the device's system clock. More specifically, it can generate a pulse with a programmable delay from an edge event input to the module.

When the module is configured for pulse generation delay by setting the TGEN bit (CTMUCON1L<12>), the internal current source is connected to the B input of Comparator 2. A Capacitor (C_{DELAY}) is connected to the Comparator 2 pin, C2INB, and the Comparator Voltage Reference, CV_{REF}, is connected to C2INA. CV_{REF} is then configured for a specific trip point. The module begins to charge C_{DELAY} when an edge event is detected. While CV_{REF} is greater than the voltage on C_{DELAY}, the CTPLS pin is high.

When the voltage on C_{DELAY} equals CV_{REF}, CTPLS goes low. With Comparator 2 configured as the second edge, this stops the CTMU from charging. In this state event, the CTMU automatically connects to ground. The IDISSEN bit doesn't need to be set and cleared before the next CTPLS cycle.

Figure 24-3 illustrates the external connections for pulse generation, as well as the relationship of the different analog modules required. While CTED1 is shown as the input pulse source, other options are available. A detailed discussion on pulse generation with the CTMU module is provided in the "*PIC24F Family Reference Manual*".

FIGURE 24-3: TYPICAL CONNECTIONS AND INTERNAL CONFIGURATION FOR PULSE DELAY GENERATION



REGISTER 24-1: CTMUCON1L: CTMU CONTROL 1 LOW REGISTER (CONTINUED)

bit 1-0 **IRNG<1:0>:** Current Source Range Select bits

11 = 100 × Base Current
10 = 10 × Base Current
01 = Base Current Level (0.55 μA nominal)
00 = 1000 × Base Current

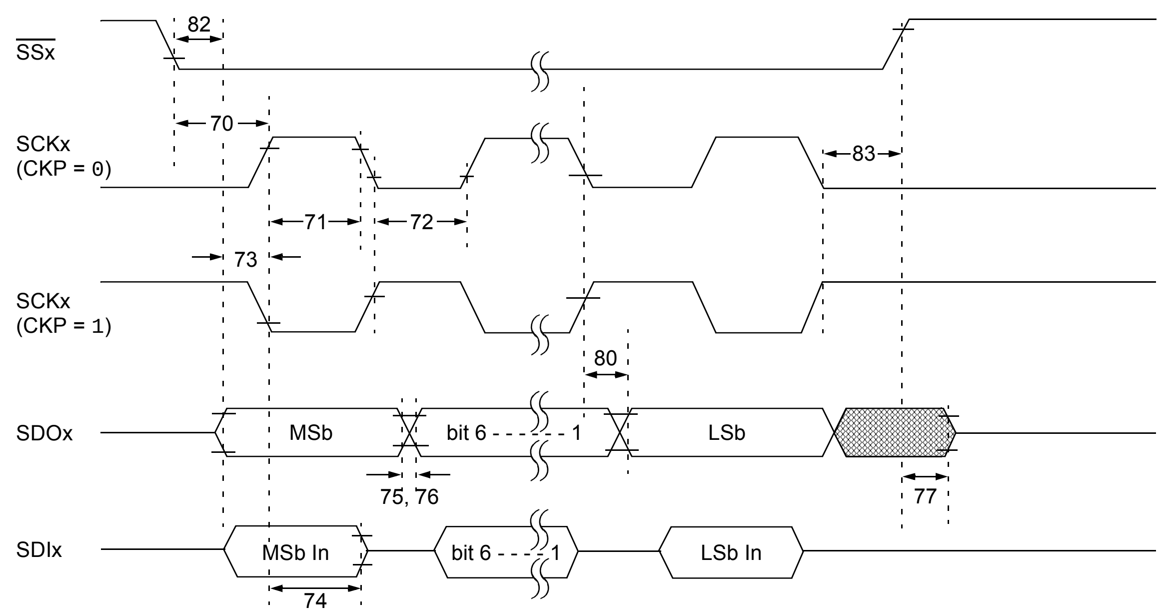
TABLE 27-6: DC CHARACTERISTICS: OPERATING CURRENT (IDD)

DC CHARACTERISTICS		Standard Operating Conditions: 1.8V to 3.6V (PIC24F16KMXXX) 2.0V to 5.5V (PIC24FV16KMXXX) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Parameter No.	**Device**	**Typical**	**Max**	**Units**	**Conditions**	
IDD Current						
D20	PIC24FV16KMXXX	269	450	μA	2.0V	0.5 MIPS, FOSC = 1 MHz(1)
		465	830	μA	5.0V	
	PIC24F16KMXXX	200	330	μA	1.8V	
		410	750	μA	3.3V	
DC22	PIC24FV16KMXXX	490	—	μA	2.0V	1 MIPS, FOSC = 2 MHz(1)
		880	—	μA	5.0V	
	PIC24F16KMXXX	407	—	μA	1.8V	
		800	—	μA	3.3V	
DC24	PIC24FV16KMXXX	13.0	15.0	mA	5.0V	16 MIPS, FOSC = 32 MHz(1)
	PIC24F16KMXXX	12.0	13.0	mA	3.3V	
DC26	PIC24FV16KMXXX	2.0	—	mA	2.0V	FRC (4 MIPS), FOSC = 8 MHz
		3.5	—	mA	5.0V	
	PIC24F16KMXXX	1.80	—	mA	1.8V	
		3.40	—	mA	3.3V	
DC30	PIC24FV16KMXXX	48.0	250	μA	2.0V	LPRC (15.5 KIPS), FOSC = 31 kHz
		75.0	275	μA	5.0V	
	PIC24F16KMXXX	8.1	28.0	μA	1.8V	
		13.50	55.00	μA	3.3V	

Legend: Unshaded rows represent PIC24F16KMXXX devices and shaded rows represent PIC24FV16KMXXX devices.

Note 1: The oscillator is in External Clock mode (FOSCSEL<2:0> = `010`, FOSC<1:0> = `00`).

FIGURE 27-14: EXAMPLE SPI SLAVE MODE TIMING (CKE = 1)



Note: Refer to Figure 27-5 for load conditions.

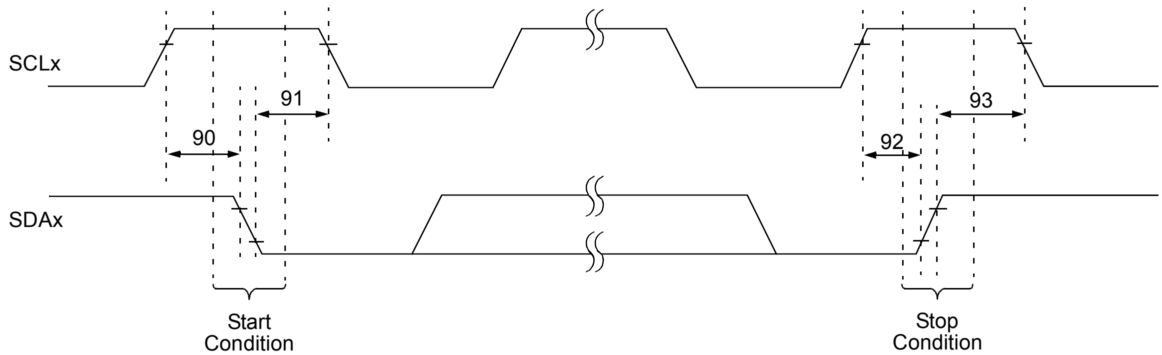
TABLE 27-32: EXAMPLE SPI SLAVE MODE REQUIREMENTS (CKE = 1)

Param No.	Symbol	Characteristic		Min	Max	Units	Conditions
70	TSSL2SCH, TSSL2SCL	$\overline{SSx}$ ↓ to SCKx ↓ or SCKx ↑ Input		3 TCY	—	ns	
70A	TSSL2WB	$\overline{SSx}$ to Write to SSPxBUF		3 TCY	—	ns	
71	TSCH	SCKx Input High Time (Slave mode)	Continuous	1.25 TCY + 30	—	ns	
71A			Single Byte	40	—	ns	**(Note 1)**
72	TSCL	SCKx Input Low Time (Slave mode)	Continuous	1.25 TCY + 30	—	ns	
72A			Single Byte	40	—	ns	**(Note 1)**
73A	TB2B	Last Clock Edge of Byte 1 to the First Clock Edge of Byte 2		1.5 TCY + 40	—	ns	**(Note 2)**
74	TSCH2DIL, TSCL2DIL	Hold Time of SDIx Data Input to SCKx Edge		40	—	ns	
75	TDOR	SDOx Data Output Rise Time		—	25	ns	
76	TDOF	SDOx Data Output Fall Time		—	25	ns	
77	TSSH2DOZ	$\overline{SSx}$ ↑ to SDOx Output High-Impedance		10	50	ns	
80	TSCH2DOV, TSCL2DOV	SDOx Data Output Valid After SCKx Edge		—	50	ns	
82	TSSL2DOV	SDOx Data Output Valid After $\overline{SSx}$ ↓ Edge		—	50	ns	
83	TSCH2SSH, TSCL2SSH	$\overline{SSx}$ ↑ After SCKx Edge		1.5 TCY + 40	—	ns	
	FSCK	SCKx Frequency		—	10	MHz	

Note 1: Requires the use of Parameter 73A.

2: Only if Parameters 71A and 72A are used.

FIGURE 27-15: I²C™ BUS START/STOP BITS TIMING

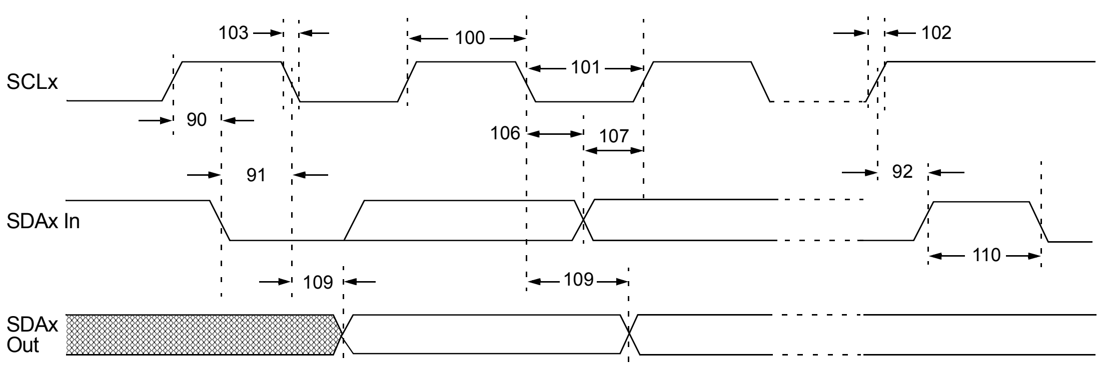


Note: Refer to Figure 27-5 for load conditions.

TABLE 27-33: I²C™ BUS START/STOP BITS REQUIREMENTS (SLAVE MODE)

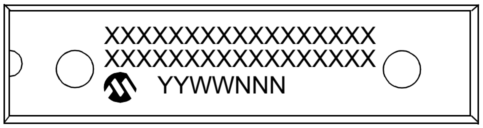
Param. No.	Symbol	Characteristic		Min	Max	Units	Conditions
90	TSU:STA	Start Condition Setup Time	100 kHz mode	4700	—	ns	Only relevant for Repeated Start condition
			400 kHz mode	600	—		
91	THD:STA	Start Condition Hold Time	100 kHz mode	4000	—	ns	After this period, the first clock pulse is generated
			400 kHz mode	600	—		
92	TSU:STO	Stop Condition Setup Time	100 kHz mode	4700	—	ns	
			400 kHz mode	600	—		
93	THD:STO	Stop Condition Hold Time	100 kHz mode	4000	—	ns	
			400 kHz mode	600	—		

FIGURE 27-16: I²C™ BUS DATA TIMING

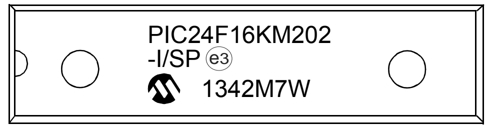


Note: Refer to Figure 27-5 for load conditions.

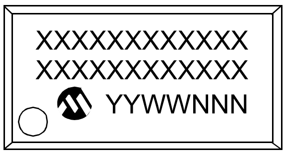
28-Lead SPDIP (.300")



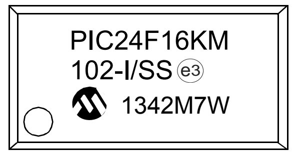
Example



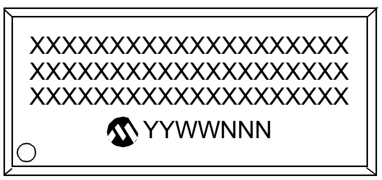
28-Lead SSOP (5.30 mm)



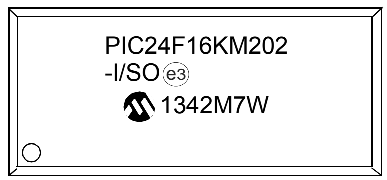
Example



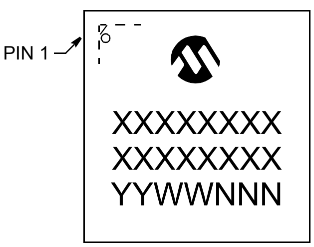
28-Lead SOIC (7.50 mm)



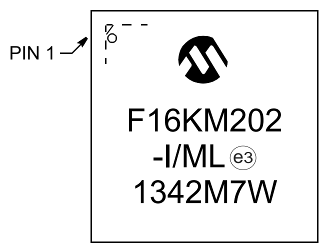
Example



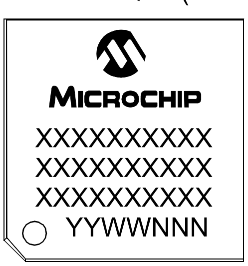
28-Lead QFN (6x6 mm)



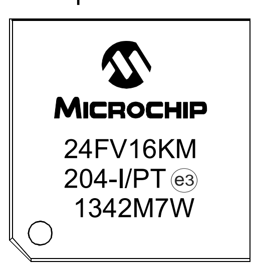
Example



44-Lead TQFP (10x10x1 mm)

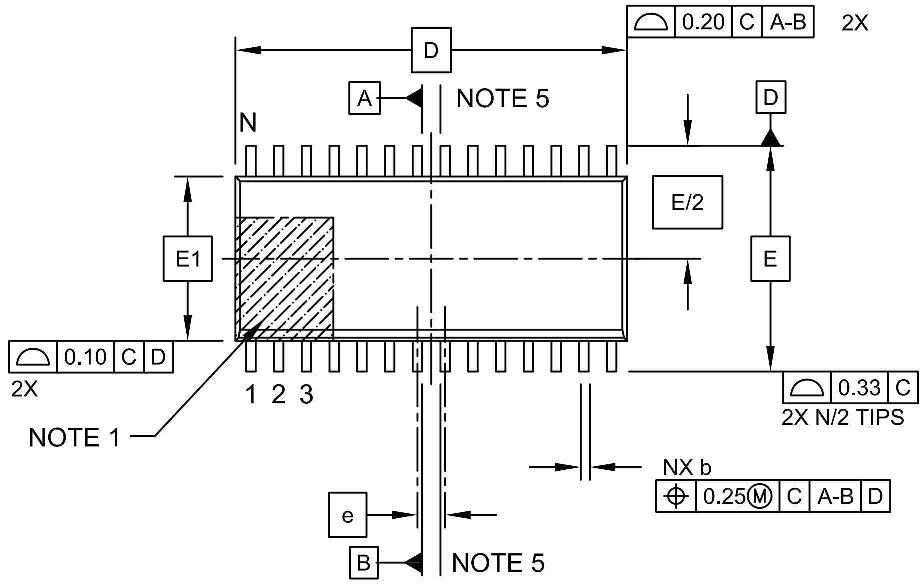


Example

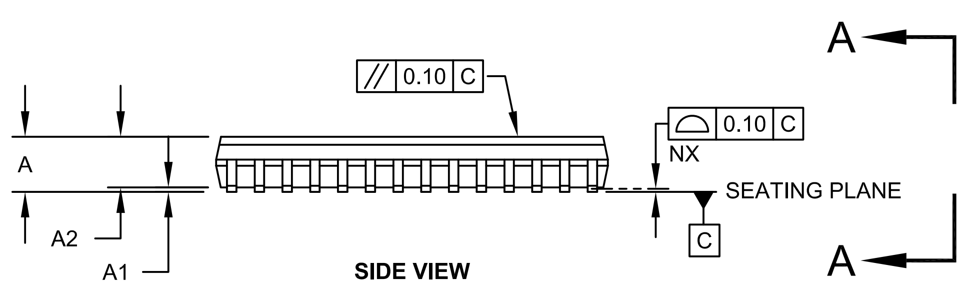


28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

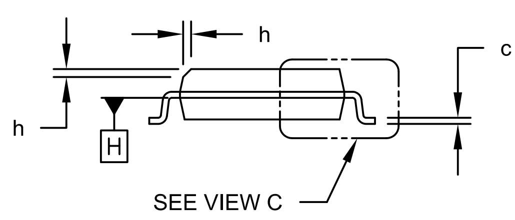
Note:	For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



TOP VIEW



SIDE VIEW



VIEW A-A

Microchip Technology Drawing C04-052C Sheet 1 of 2